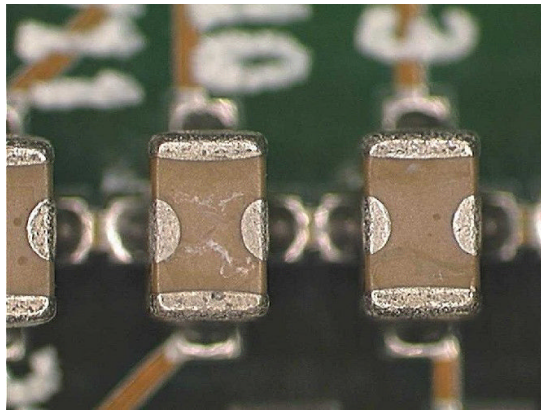


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Handbook for Lead Free High Electronic Reliability Printed Circuits



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